

18 V, 12 A Step-Down Regulator with Programmable Current Limit

Data Sheet

FEATURES

Input voltage: 4.5 V to 18 V Continuous output current: 12 A Integrated MOSFETs: 17 m Ω high-side/4.5 m Ω low-side 0.6 V \pm 0.5% reference voltage Programmable switching frequency range: 200 kHz to 2200 kHz Enhanced transient response Programmable current limit with \pm 10% accuracy Precision enable and power good External compensation and soft start PFM mode (ADP2390 only) Start up into a precharged output Supported by the ADIsimPower design tool

APPLICATIONS

Communication infrastructure Networking and servers Industrial and instrumentation Healthcare and medical Intermediate power rail conversions DC-to-DC point of load applications

GENERAL DESCRIPTION

The ADP2389/ADP2390 are current mode control, synchronous step-down, dc-to-dc regulators. They integrate a 17 m Ω high-side power MOSFET and a 4.5 m Ω synchronous rectifier MOSFET to provide a high efficiency solution. The ADP2390 operates in pulse frequency modulation (PFM) mode to improve the system efficiency at light load. The ADP2389/ADP2390 run from an input voltage of 4.5 V to 18 V and can deliver up to 12 A of output current. The output voltage can be adjusted to 0.6 V and the switching frequency can be programmed between 200 kHz to 2200 kHz.

The ADP2389/ADP2390 target high performance applications that require high efficiency and design flexibility. External compensation and soft start provide design flexibility. The power-good output and precision enable input provide simple and reliable power sequencing. An enhanced transient response feature improves the load transient performance, which reduces the output capacitance. Programmable current limit allows the user to optimized the inductor design and provide a compact solution.

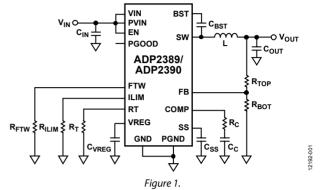
Other key features include undervoltage lockout (UVLO), overvoltage protection (OVP), overcurrent protection (OCP), and thermal shutdown (TSD).

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ADP2389/ADP2390

TYPICAL APPLICATIONS CIRCUIT



The ADP2389/ADP2390 operates over a -40° C to $+125^{\circ}$ C junction temperature range and is available in 32-lead, 5 mm × 5 mm LFCSP package.

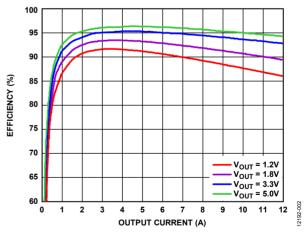


Figure 2. ADP2389 Efficiency vs. Output Current, VIN = 12 V, f_{SW} = 300 kHz

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TABLE OF CONTENTS

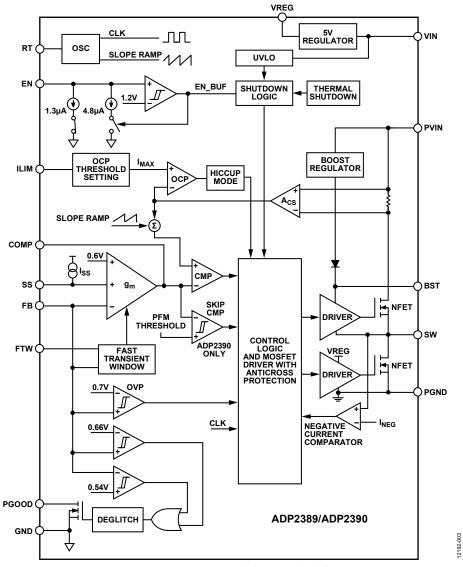
| Features | 1 |
|--|---|
| Applications | 1 |
| Typical Applications Circuit | 1 |
| General Description | 1 |
| Revision History | 2 |
| Detailed Functional Block Diagram | 3 |
| Specifications | 4 |
| Absolute Maximum Ratings | 6 |
| Thermal Information | 6 |
| ESD Caution | 6 |
| Pin Configuration and Function Descriptions | 7 |
| Typical Performance Characteristics | 8 |
| Theory of Operation1 | 2 |
| Control Scheme 1 | 2 |
| PFM Mode (ADP2390 Only)1 | 2 |
| Precision Enable/Shutdown1 | 2 |
| Internal Regulator (VREG)1 | 2 |
| Bootstrap Circuitry1 | 2 |
| Oscillator1 | 2 |
| Soft Start1 | 3 |
| Fast Transient Response1 | 3 |
| Power Good1 | 3 |
| Peak Current-Limit and Short-Circuit Protection1 | 3 |
| Overvoltage Protection (OVP)1 | 3 |

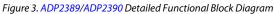
| Undervoltage Lockout (UVLO) | 13 |
|--------------------------------------|----|
| Thermal Shutdown | 13 |
| Applications Information | 14 |
| Input Capacitor Selection | 14 |
| Output Voltage Setting | 14 |
| Inductor Selection | 14 |
| Output Capacitor Selection | 15 |
| Programming Input Voltage UVLO | 15 |
| Compensation Design | 15 |
| Design Example | 17 |
| Output Voltage Setting | 17 |
| Frequency Setting | 17 |
| Inductor Selection | 17 |
| Output Capacitor Selection | 17 |
| Compensation Components | 18 |
| Soft Start Time Program | 18 |
| Input Capacitor Selection | 18 |
| Schematic for Design Example | 18 |
| External Components Recommendation | 19 |
| Circuit Board Layout Recommendations | 20 |
| Typical Application Circuits | 22 |
| Outline Dimensions | 23 |
| Ordering Guide | 23 |

REVISION HISTORY

8/15—Revision 0: Initial Version

DETAILED FUNCTIONAL BLOCK DIAGRAM





SPECIFICATIONS

 $V_{PVIN} = V_{VIN} = 12 \text{ V}, T_J = -40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$ for minimum/maximum specifications, and $T_A = 25^{\circ}\text{C}$ for typical specifications, unless otherwise noted.

| Table 1. | - | | | | | |
|---|----------------------|----------------------------------|-------|-------|-------|------------|
| Parameter | Symbol | Test Conditions/Comments | Min | Тур | Мах | Units |
| SUPPLY VOLTAGE (PVIN AND VIN) | | | | | | |
| PVIN Voltage Range | V _{PVIN} | | 4.5 | | 18 | V |
| VIN Voltage Range | V _{VIN} | | 4.5 | | 18 | V |
| Quiescent Current | lq | No switching | | 1.16 | 1.5 | mA |
| Shutdown Current | I _{SHDN} | EN = GND | | 7.5 | 20 | μA |
| VIN Undervoltage Lockout Threshold | UVLO | VIN rising | | 4.2 | 4.4 | V |
| | | VIN falling | 3.5 | 3.7 | | V |
| FEEDBACK (FB) | | | | | | |
| FB Regulation Voltage | V _{FB} | 0°C < T」 < 85°C | 0.597 | 0.6 | 0.603 | V |
| | | –40°C < T」 < +125°C | 0.594 | 0.6 | 0.606 | V |
| FB Bias Current | I _{FB} | | | 0.01 | 0.1 | μΑ |
| ERROR AMPLIFIER (EA) | | | | | | |
| Transconductance | g _m | | 450 | 500 | 550 | μS |
| EA Source Current | | | 40 | 50 | 60 | μA |
| EA Sink Current | Isink | | 40 | 50 | 60 | μA |
| INTERNAL REGULATOR (VREG) | | | | | | |
| VREG Voltage | VVREG | $I_{VREG} = 10 \text{ mA}$ | 4.8 | 5 | 5.2 | v |
| Dropout Voltage | - VILO | $V_{\text{REG}} = 50 \text{ mA}$ | | 355 | | mV |
| Regulator Current Limit | | | | 100 | | mA |
| SWITCH NODE (SW) | | | | | | |
| On Resistance ¹ | | | | | | |
| High-Side | Rdson H | $V_{BOOT} = 5 V$ | | 17 | 30 | mΩ |
| Low-Side | R _{DSON_L} | $V_{\text{VREG}} = 5 \text{ V}$ | | 4.5 | 9 | mΩ |
| SW Minimum On Time ² | | | | 100 | 2 | ns |
| SW Minimum Off Time ² | t _{MIN_OFF} | | | 150 | | ns |
| CURRENT LIMIT | CMIN_OFF | | | 150 | | 115 |
| ILIM Voltage | VILIM | | | 0.592 | | v |
| ILIM Current Range | | | 1.8 | 0.572 | 12 | μA |
| High-Side Peak Current Limit | | R _{IUM} = 59 kΩ | 1.0 | 16.8 | 18.6 | A |
| Low-Side Negative Current Limit ² | IOCF | | 15 | 4 | 10.0 | A |
| BST | | | | | | ~ |
| Bootstrap Voltage | V _{BOOT} | | 4.6 | 5 | 5.4 | v |
| OSCILLATOR (RT) | • BOOT | | 1.0 | 5 | 5.1 | • |
| Switching Frequency | fsw | R _T = 100 kΩ | 540 | 600 | 660 | kHz |
| Switching Frequency Switching Frequency Range | 1200 | M = 100 K22 | 200 | 000 | 2200 | кпz kHz |
| FAST TRANSIENT WINDOW (FTW) | | | 200 | | 2200 | NITZ |
| | | $R_{FTW} = 100 \ k\Omega$ | | ±2 | | % |
| Fast Transient Response Window Minimum Fast Transient Response Window ² | | NFTW - 100 K12 | | ±2 | | |
| • | | | | ±1 | | % |
| SS | . | | 2 7 | 2.4 | 4 1 | |
| SS Pin Pull-Up Current | I _{SS} | | 2.7 | 3.4 | 4.1 | μΑ |

Data Sheet

ADP2389/ADP2390

| Parameter | Symbol | Test Conditions/Comments | Min | Тур | Max | Units |
|-----------------------------|--------|----------------------------|------|------|------|--------|
| PGOOD | | | | | | |
| FB Threshold | | | | | | |
| Rising | | | 106 | 110 | 114 | % |
| Falling | | | 86 | 90 | 94 | % |
| FB Hysteresis | | | | | | |
| Rising | | | | 5 | | % |
| Falling | | | | 5 | | % |
| Power-Good Deglitch Time | | PGOOD from low to high | | 16 | | Cycles |
| | | PGOOD from high to low | | 16 | | Cycles |
| PGOOD Leakage Current | | $V_{PGOOD} = 5 V$ | | 0.01 | 0.1 | μΑ |
| PGOOD Output Low Voltage | | $I_{PGOOD} = 1 \text{ mA}$ | | 150 | 260 | mV |
| EN | | | | | | |
| EN Rising Threshold | | | | 1.2 | 1.28 | V |
| EN Falling Threshold | | | 1.02 | 1.1 | | V |
| EN Source Current | | EN voltage < 1.1 V | | 6.1 | | μΑ |
| | | EN voltage > 1.2 V | | 1.3 | | μΑ |
| THERMAL | | | | | | |
| Thermal Shutdown Threshold | | | | 150 | | °C |
| Thermal Shutdown Hysteresis | | | | 25 | | °C |

¹ Pin-to-pin measurement. ² Guaranteed by design.

ABSOLUTE MAXIMUM RATINGS

Table 2.

| Parameter | Rating |
|--------------------------------------|-----------------------|
| PVIN, VIN, EN, PGOOD | –0.3 V to +22 V |
| SW | –1 V to +22 V |
| BST | V _{sw} + 6 V |
| FB, SS, COMP, RT, ILIM, FTW, VREG | –0.3 V to +6 V |
| PGND to GND | –0.3 V to +0.3 V |
| Operating Junction Temperature Range | -40°C to +125°C |
| Storage Temperature Range | –65°C to +150°C |
| Soldering Conditions | JEDEC J-STD-020 |

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

Unless otherwise specified, all other voltages are referenced to GND.

THERMAL INFORMATION

 θ_{JA} is specified for the worst-case conditions, that is, a device soldered in a circuit board (4-layer, JEDEC standard board) for surface-mount packages.

Table 3. Thermal Resistance

| Package Type | θ _{JA} | θ」 | Unit |
|---------------|-----------------|-----|------|
| 32-Lead LFCSP | 41 | 2.2 | °C/W |

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

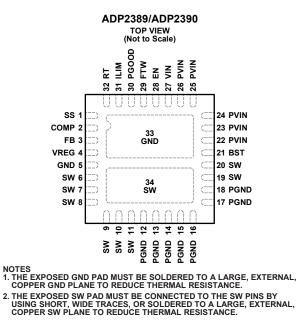


Figure 4. Pin Configuration (Top View)

2192-004

Table 4. Pin Function Descriptions

| | Table 4. Fin Function Descriptions | | | | | |
|-----------------|------------------------------------|--|--|--|--|--|
| Pin No. | Mnemonic | Description | | | | |
| 1 | SS | Soft Start Control. Connect a capacitor from the SS pin to GND to program the soft start time. | | | | |
| 2 | COMP | Error Amplifier Output. Connect an RC network from the COMP pin to GND. | | | | |
| 3 | FB | Feedback Voltage Sense Input. Connect this pin to a resistor divider from the output voltage, V_{OUT} . | | | | |
| 4 | VREG | Output of the Internal 5 V Regulator. The control circuits are powered from this voltage. Place a 1 μF, X7R or X5R ceramic capacitor between this pin and GND. | | | | |
| 5 | GND | Analog Ground. | | | | |
| 6 to 11, 19, 20 | SW | Switch Node. Connect this pin to an inductor. | | | | |
| 12 to 18 | PGND | Power Ground. Return of the low-side MOSFET. | | | | |
| 21 | BST | Supply Rail for the High-Side Gate Drive. Place a 0.1 μ F, X7R or X5R capacitor between SW and BST. | | | | |
| 22 to 26 | PVIN | Power Input. Connect PVIN to the input power source and connect a bypass capacitor between this pin and PGND. | | | | |
| 27 | VIN | Power Input for Control Circuitry. Bypass VIN to GND with a low equivalent series resistance (ESR) capacitor as close to the device as possible. Connect VIN to PVIN directly. | | | | |
| 28 | EN | Precision Enable. Use an external resistor divider to set the turn on threshold. To enable the device automatically, connect the EN pin to PVIN. | | | | |
| 29 | FTW | Fast Transient Response Window Setting. Connect a resistor between the FTW pin and GND to set the fast transient response window. | | | | |
| 30 | PGOOD | Power-Good Output (Open-Drain). Connecting a 10 k Ω to 100 k Ω pull-up resistor from PGOOD to a pull-up voltage is recommended. | | | | |
| 31 | ILIM | Current-Limit Threshold Setting. Connect a resistor from the ILIM pin to GND to program the current-limit threshold. | | | | |
| 32 | RT | Frequency Setting. Connect a resistor between the RT pin and GND to program the switching frequency between 200 kHz to 2.2 MHz. | | | | |
| 33 | EP, GND | Exposed GND Pad. The exposed GND pad must be soldered to a large, external, copper GND plane to reduce thermal resistance. | | | | |
| 34 | EP, SW | Exposed SW Pad. The exposed SW pad must be connected to the SW pins by using short, wide traces, or soldered to a large, external, copper SW plane to reduce thermal resistance. | | | | |

INDUCTOR: 744 333 0220

V_{OUT} = 1.0V V_{OUT} = 1.2V V_{OUT} = 1.2V V_{OUT} = 1.5V V_{OUT} = 1.8V

V_{OUT} = 3.3V V_{OUT} = 5.0V

INDUCTOR: 744 333 0220

V_{OUT} = 1.0V V_{OUT} = 1.2V

 $V_{OUT} = 1.5V$ $V_{OUT} = 1.8V$ $V_{OUT} = 2.5V$

V_{OUT} = 3.3V V_{OUT} = 5.0V

T_{.1} = -40°C

T_J = +25°C T_J = +125°C

16

14

2192-010

18

10

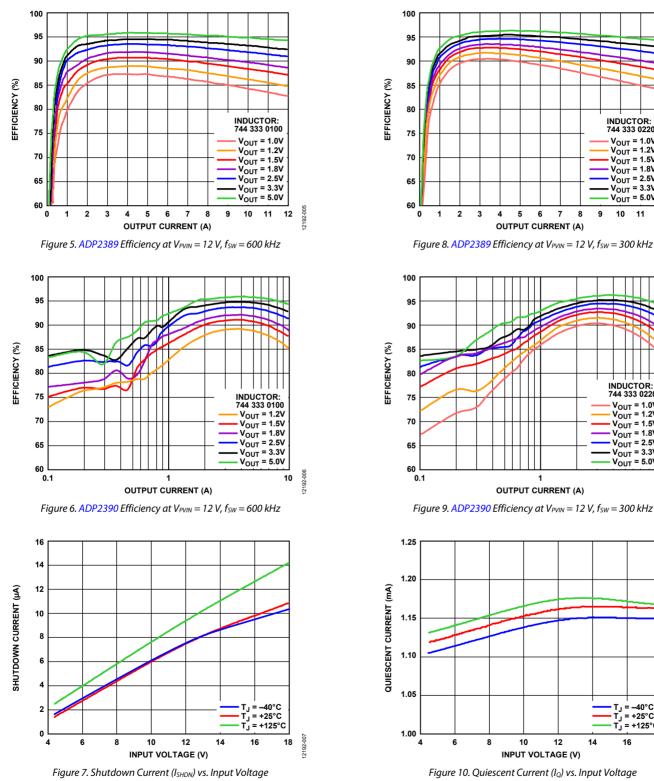
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10 11

9

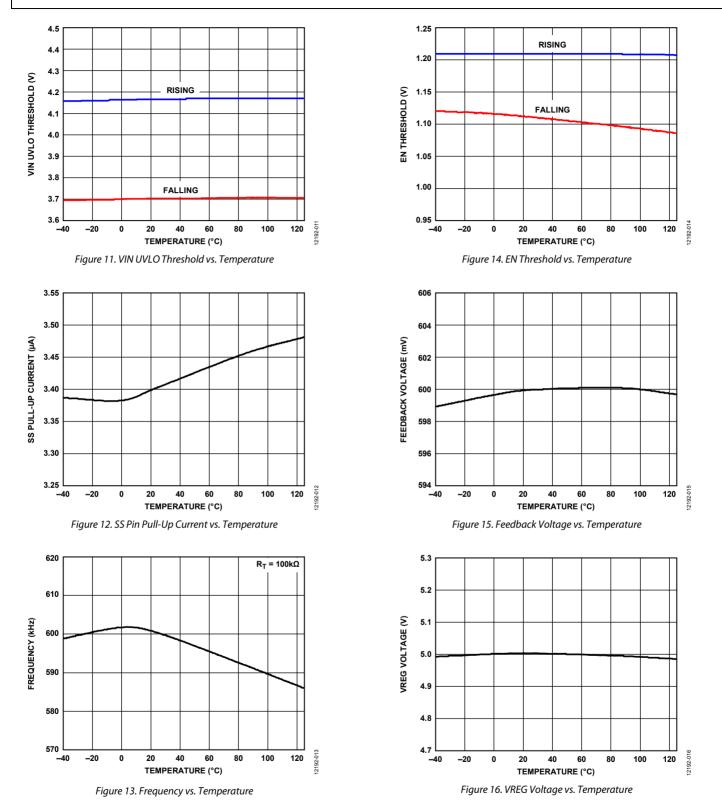
TYPICAL PERFORMANCE CHARACTERISTICS

 $T_A = 25^{\circ}C$, $V_{PVIN} = V_{VIN} = 12$ V, $V_{OUT} = 1.8$ V, $L = 1 \mu$ H, $C_{OUT} = 5 \times 100 \mu$ F, $f_{SW} = 500$ kHz, unless otherwise noted.

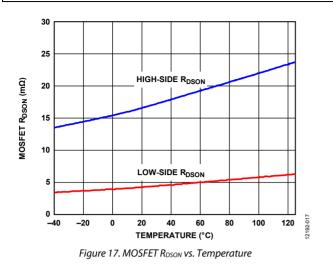


Data Sheet

ADP2389/ADP2390



ADP2389/ADP2390



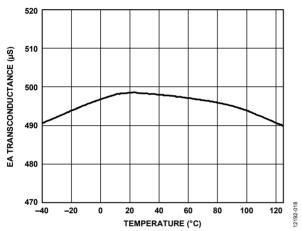
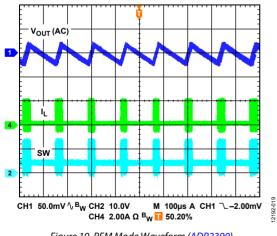
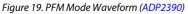


Figure 18. EA Transconductance vs. Temperature





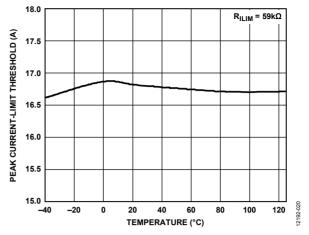
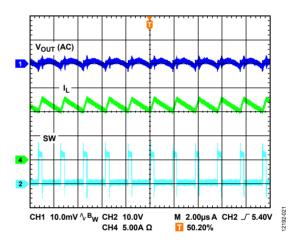
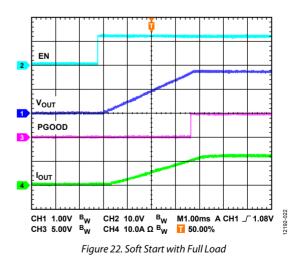


Figure 20. Peak Current-Limit Threshold vs. Temperature







Data Sheet

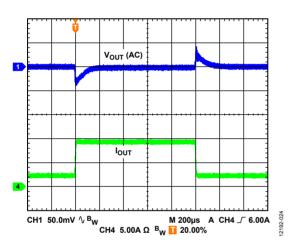
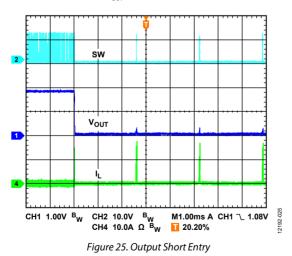


Figure 24. Load Transient Response with Fast Transient Enable, $I_{OUT} = 2.4 \text{ A to } 9.6 \text{ A}$



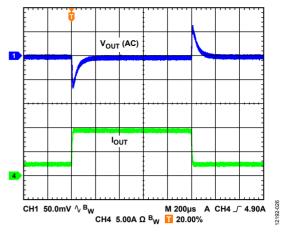
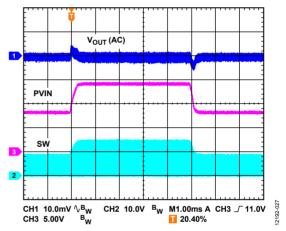
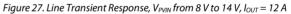
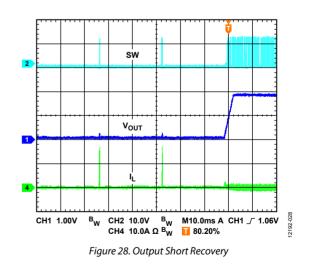


Figure 26. Load Transient Response, $I_{OUT} = 2.4 \text{ A to } 9.6 \text{ A}$







ADP2389/ADP2390

THEORY OF OPERATION

The ADP2389/ADP2390 are synchronous step-down, dc-to-dc regulators. These devices use a current-mode control architecture with an integrated high-side power switch and a low-side synchronous rectifier. The regulators target high performance applications that require high efficiency and design flexibility.

The ADP2389/ADP2390 can operate with an input voltage from 4.5 V to 18 V and can regulate the output voltage to 0.6 V. Additional features added for design flexibility include programmable switching frequency, programmable soft start, programmable current limit, external compensation, precision enable, and a power-good output.

CONTROL SCHEME

The ADP2389/ADP2390 use a fixed frequency, peak current mode pulse-width modulation (PWM) control architecture. At the start of each oscillator cycle, the high-side MOSFET turns on, adding a positive voltage across the inductor. The current in the inductor (I_L) increases until the current sense signal crosses the peak inductor current threshold that turns off the high-side MOSFET and turns on the low-side MOSFET. This action adds a negative voltage across the inductor, causing the inductor current to decrease. The low-side MOSFET remains on for the rest of cycle.

PFM MODE (ADP2390 ONLY)

The ADP2390 can work in PFM mode during a light load. When the COMP pin voltage is below the PFM threshold voltage, the device enters PFM mode. In PFM mode, the device monitors the FB voltage to regulate the output voltage. Because the high-side and low-side MOSFETs are turned off, the load current discharges the output capacitor, causing the output voltage to drop. When the FB voltage drops below 0.605 V, the device begins switching and the output voltage increases as the output capacitor is charged by the inductor current. When the FB voltage exceeds 0.62 V, the device turns off both the high-side and low-side MOSFETs until the FB voltage drops to 0.605 V. In the PFM mode, the output voltage ripple is greater than the ripple in the PWM mode.

PRECISION ENABLE/SHUTDOWN

The EN input pin has a precision analog threshold of 1.2 V (typical) with 100 mV of hysteresis. When the enable pin (EN) voltage exceeds 1.2 V, the regulator turns on; when it falls below 1.1 V (typical), the regulator turns off. To force the regulator to start automatically when input power is applied, connect the EN pin to PVIN.

The precision EN pin has an internal pull-down current source (5 μ A) that provides a default turn off when the EN pin is open.

When the EN pin voltage exceeds 1.2 V (typical), the ADP2389/ADP2390 are enabled and the internal pull-down current source at the EN pin decreases to 1 μ A, which allows users to program the PVIN UVLO and hysteresis.

INTERNAL REGULATOR (VREG)

The on-board regulator provides a stable supply for the internal circuits. Place a 1 μ F, X7R or X5R ceramic capacitor between the VREG pin and GND. The internal regulator includes a current-limit circuit to protect the output if the maximum external load current is exceeded.

BOOTSTRAP CIRCUITRY

The ADP2389/ADP2390 include a boot strap regulator to provide the gate drive voltage for the high-side MOSFET. The boot strap regulator uses differential sensing to generate a 5 V bootstrap voltage between the BST pin and the SW pin.

Place a 0.1 $\mu\text{F},$ X7R or X5R ceramic capacitor between the BST pin and the SW pin.

OSCILLATOR

The switching frequency of the ADP2389/ADP2390 (f_{sw}) is controlled by the RT pin. A resistor (R_T) from the RT pin to GND can program the switching frequency according to the following equation:

$$f_{sw}(kHz) = \frac{67,000}{R_r(k\Omega) + 12}$$

A 100 k Ω resistor sets the switching frequency to 600 kHz, and a 44.2 k Ω resistor sets the switching frequency to 1.2 MHz. Figure 29 shows the typical relationship between f_{SW} and R_T.

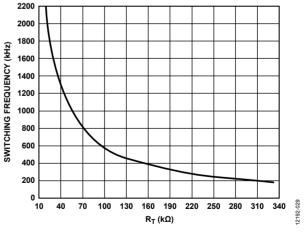


Figure 29. Switching Frequency (fsw) vs. RT

SOFT START

The SS pin programs the soft start time. Place a capacitor between the SS pin and GND; an internal current charges this capacitor to establish the soft start ramp. Calculate the soft start time using the following equation:

$$t_{\rm SS} = \frac{0.6 \ V \times C_{\rm SS}}{I_{\rm SS}}$$

where:

 C_{SS} is the soft start capacitance. I_{SS} is the soft start pull-up current (3.4 μ A).

If the output voltage is precharged before power-up, the ADP2389/ ADP2390 prevent the low-side MOSFET from turning on until the soft start voltage exceeds the voltage on the FB pin.

FAST TRANSIENT RESPONSE

The ADP2389/ADP2390 use the FTW pin to set the fast transient response window. Place a resistor (R_{FTW}) between the FTW pin and GND to program the window. Calculate the window threshold using the following equation:

Window Threshold =
$$\frac{200}{R_{FTW}(k\Omega) + 1}$$
%

If the output voltage is greater than the setting window, the fast transient response is enabled. The fast transient response function is disabled if the FTW pin is open and the minimum window is 1%.

To avoid false trigger of the fast transient, the window threshold must be $2\times$ greater than the output ripple.

POWER GOOD

The power-good (PGOOD) pin is an active high, open-drain output that requires an external resistor to pull it up to a voltage. A logic high on the PGOOD pin indicates that the voltage at the FB pin (and thus the output voltage) is within $\pm 10\%$ of the desired value, and there is a 16 cycle waiting period before PGOOD is pulled high. A logic low indicates that the voltage at the FB pin is out of $\pm 10\%$ of the desired value, and there is a 16-cycle waiting period before PGOOD is pulled low.

PEAK CURRENT-LIMIT AND SHORT-CIRCUIT PROTECTION

The ADP2389/ADP2390 have a cycle-by-cycle peak currentlimit protection circuit to prevent current runaway. A resistor (R_{ILIM}) from the ILIM pin to GND programs the peak currentlimit threshold according to the following equation:

$$I_{OCP}(A) = \frac{1000}{R_{ILIM}(k\Omega) + 0.5}$$

ADP2389/ADP2390

For protection against heavy loads, the ADP2389/ADP2390 use a hiccup mode for overcurrent protection. When the inductor T turns off and the low-side MOSFET turns on until the next cycle. The overcurrent counter increments during this process. If the overcurrent counter reaches four or the FB pin voltage falls to 0.2 V after the soft start, the device enters hiccup mode. During hiccup mode, the high-side MOSFET and the low-side both turn off. The device remains in this mode for seven soft start times and then attempts to restart from soft start. If the current-limit fault is cleared, the device resumes normal operation; otherwise, it reenters hiccup mode.

In some cases, the input voltage (PVIN) ramp rate is too slow, or the output capacitor is too large for the output to reach regulation during the soft start process, which causes the regulator to enter hiccup mode. To avoid such cases, use a resistor divider at the EN pin to program the input voltage UVLO, or use a longer soft start time.

OVERVOLTAGE PROTECTION (OVP)

The ADP2389/ADP2390 include an OVP feature that protects the regulator against an output short to a higher voltage supply or against a strong load disconnect transient. If the feedback voltage increases to 0.7 V, the internal high-side MOSFET and low-side MOSFET turn off until the voltage at FB decreases to 0.63 V. At that time, the ADP2389/ADP2390 resumes normal operation.

UNDERVOLTAGE LOCKOUT (UVLO)

The undervoltage lockout (UVLO) threshold is 4.2 V with a 0.5 V hysteresis, which prevents power-on glitches from occurring. When the VIN voltage rises above 4.2 V, the device enables and the soft start period initiates. When the VIN voltage drops below 3.7 V, the device turns off.

THERMAL SHUTDOWN

In the event that the ADP2389/ADP2390 junction temperatures rises above 150°C, the internal thermal shutdown circuit turns off the regulator for self protection. Extreme junction temperatures can be the result of high current operation, poor circuit board thermal design, and/or high ambient temperature. A 25°C hysteresis is included in the thermal shutdown circuit so that if an overtemperature event occurs, the ADP2389/ADP2390 does not return to normal operation until the on-chip temperature drops below 125°C. Upon recovery, a soft start initiates before normal operation.

APPLICATIONS INFORMATION INPUT CAPACITOR SELECTION

The input decoupling capacitor attenuates high frequency noise on the input. This capacitor must be a ceramic type in the range of 10 μ F to 47 μ F Place the capacitor close to the PVIN pin. Keep the loop composed by this input capacitor, high-side MOSFET and low-side MOSFET as small as possible.

The voltage rating of the input capacitor must be greater than the maximum input voltage. The rms current rating of the input capacitor must be larger than the value calculated from the following equation:

$$I_{CIN_RMS} = I_{OUT} \times \sqrt{D \times (1 - D)}$$

where:

*I*_{OUT} is the output current. *D* is the duty cycle.

OUTPUT VOLTAGE SETTING

An external resistor divider sets the output voltages of the ADP2389/ADP2390. Calculate the resistor values using the following equation:

$$V_{OUT} = 0.6 \times \left(1 + \frac{R_{TOP}}{R_{BOT}} \right)$$

where :

 R_{TOP} is the top feedback resistor. R_{BOT} is the bottom feedback resistor.

To limit output voltage accuracy degradation due to FB bias current (0.1 μ A maximum) to less than 0.5% (maximum), ensure that R_{BOT} is less than 30 k Ω .

Table 5 gives the recommended resistor divider for various output voltages.

| Table 5. Resistor | Divider for l | Difference C | Output Voltage |
|-------------------|---------------|---------------------|---|
| 1 | | | all |

| Vout (V) | R _{TOP} , ±1% (kΩ) | R _{BOT} , ±1% (kΩ) |
|----------|-----------------------------|-----------------------------|
| 1.0 | 10 | 15 |
| 1.2 | 10 | 10 |
| 1.5 | 15 | 10 |
| 1.8 | 20 | 10 |
| 2.5 | 47.5 | 15 |
| 3.3 | 10 | 2.21 |
| 5.0 | 22 | 3 |

INDUCTOR SELECTION

The inductor value is determined by the operating frequency, the input voltage, output voltage, and inductor ripple current. Using a small inductor leads to a faster transient response; however, it degrades efficiency due to its larger inductor ripple current. Using a large inductor value leads to smaller ripple current and better efficiency but results in a slower transient response. As a guideline, the inductor ripple current, ΔI_L , is typically set to one third of the maximum load current. Calculate the inductor value using the following equation:

$$L = \frac{(V_{IN} - V_{OUT}) \times D}{\Delta I_L \times f_{SW}}$$

where:

 V_{IN} is the input voltage. V_{OUT} is the output voltage. D is the duty cycle. ΔI_L is the inductor ripple current. f_{SW} is the switching frequency.

$$D = \frac{V_{OUT}}{V_{IN}}$$

The peak inductor current ($I_{\mbox{\scriptsize PEAK}})$ is calculated using

$$I_{\rm PEAK} = I_{\rm OUT} + \frac{\Delta I_{\rm L}}{2}$$

The saturation current of the inductor must be greater than the peak inductor current. For the ferrite core inductors with a quick saturation characteristic, the saturation current rating (I_{SAT}) of the inductor must be greater than the current-limit threshold of the switch to prevent the inductor from being saturated.

Calculate the rms current of the inductor (I_{RMS}) from the following equation:

$$I_{RMS} = \sqrt{I_{OUT}^2 + \frac{\Delta I_L^2}{12}}$$

Shielded ferrite core materials are recommended for low core loss and low electromagnetic interference (EMI). Table 6 lists recommended inductors.

Table 6. Recommended Inductors

| Vendor | Device No. | Value (µH) | I _{SAT} (A) | I _{RMS} (A) | DCR (mΩ) |
|------------|------------------|---------------|-------------------------|-------------------------|-------------|
| CoilCraft | XAL7030-102ME | 1 | 21.8 | 16.1 | 4.55 |
| | XAL7030-152ME | 1.5 | 11.9 | 23.5 | 7.6 |
| | XAL7030-222ME | 2.2 | 10 | 18 | 13.7 |
| Toko | FDUE1040D-H-R22M | 0.22 | 32 | 32 | 0.64 |
| | FDUE1040D-H-R45M | 0.45 | 27 | 24 | 1.02 |
| | FDU1040D-H-R68M | 0.68 | 21 | 20 | 1.7 |
| | FDUE1040D-H-1R0M | 1.0 | 18 | 16 | 2.35 |
| | FDA1254-H-1R2M | 1.2 | 20.2 | 18.4 | 2.6 |
| Würth | 744 333 0022 | 0.22 | 60 | 21.5 | 0.6 |
| Elektronik | 744 333 0047 | 0.47 | 47 | 20 | 0.8 |
| | 744 333 0068 | 0.68 | 38 | 20 | 1.35 |
| | 744 333 0082 | 0.82 | 36 | 20 | 1.35 |
| | 744 332 0100 | 1.0 | 27.5 | 20 | 1.35 |
| | 744 325 120 | 1.2 | 25 | 20 | 1.8 |
| | 744 333 0150 | 1.5 | 27 | 18 | 2.5 |
| | 744 333 0220 | 2.2 | 22 | 16 | 3.7 |

OUTPUT CAPACITOR SELECTION

The output capacitor selection affects both the output ripple voltage and the loop dynamics of the regulator.

During a step load transient, for instance, when the load is suddenly increased, the output capacitor supplies the load until the control loop ramps up the inductor current. The delay caused by the control loop causes the output to undershoot. Use the following equation to calculate the output capacitance required to satisfy the voltage droop requirement:

$$C_{OUT_{-UV}} = \frac{K_{UV} \times \Delta I_{STEP}^2 \times L}{2 \times (V_{IN} - V_{OUT}) \times \Delta V_{OUT_{-UV}}}$$

where:

 K_{UV} is a factor; the typical setting is $K_{UV} = 2$. ΔI_{STEP} is the load step.

 ΔV_{OUT_UV} is the allowable undershoot on the output voltage.

When a load is suddenly removed from the output and the energy stored in the inductor rushes into the output capacitor, the output overshoots. Calculate the output capacitance required to meet the overshoot requirement using the following equation:

$$C_{OUT_OV} = \frac{K_{OV} \times \Delta I_{STEP}^{2} \times L}{2 \times (V_{OUT} - \Delta V_{OUT} OV) - V_{OUT}}$$

where:

 K_{OV} is a factor; the typical setting is $K_{OV} = 2$.

 ΔI_{STEP} is the load step.

 ΔV_{OUT_OV} is the allowable overshoot on the output voltage.

The output ripple is determined by the ESR and the value of the capacitance. Use the following equations to select a capacitor that can meet the output ripple requirements:

$$C_{OUT_RIPPLE} = \frac{\Delta I_L}{8 \times f_{SW} \times \Delta V_{OUT_RIPPLE}}$$

where $\Delta V_{OUT_{RIPPLE}}$ is the allowable output ripple voltage.

$$R_{ESR} = \frac{\Delta V_{OUT_RIPPLE}}{\Delta I_L}$$

where *R*_{ESR} is the equivalent series resistance of the output capacitor in ohms.

Select the largest output capacitance given by C_{OUT_UV} , C_{OUT_OV} , and C_{OUT_RIPPLE} to meet both load transient and output ripple performance.

The selected output capacitor voltage rating must be greater than the output voltage. The rms current rating of the output capacitor must be greater than the value calculated using the following equation:

$$I_{COUT_RMS} = \frac{\Delta I_L}{\sqrt{12}}$$

PROGRAMMING INPUT VOLTAGE UVLO

The ADP2389/ADP2390 have a precision enable input that programs the UVLO threshold of the input voltage, as shown in Figure 30.

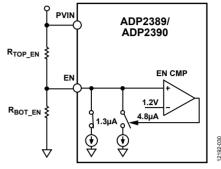


Figure 30. Programming the Input Voltage UVLO

Use the following equations to calculate R_{TOP_EN} and R_{BOT_EN}:

$$R_{TOP_EN} = \frac{1.1 \text{ V} \times V_{IN_RISING} - 1.2 \text{ V} \times V_{IN_FALLING}}{1.1 \text{ V} \times 6.1 \mu\text{A} - 1.2 \text{ V} \times 1 \mu\text{A}}$$

where:

 V_{IN_RISING} is the V_{IN} rising threshold. $V_{IN_FALLING}$ is the V_{IN} falling threshold.

$$R_{BOT_{EN}} = \frac{1.2 \text{ V} \times R_{TOP_{EN}}}{V_{IN_{RISING}} - R_{TOP_{EN}} \times 6.1 \,\mu\text{A} - 1.2 \text{ V}}$$

COMPENSATION DESIGN

For peak current mode control, the power stage can be simplified as a voltage controlled current source supplying current to the output capacitor and load resistor. It is composed of one domain pole and a zero contributed by the output capacitor ESR. The control to output transfer function is shown with the following equations:

$$G_{VD}(s) = \frac{V_{OUT}(s)}{V_{COMP}(s)} = A_{VT} \times R \times \frac{\left(1 + \frac{s}{2 \times \pi \times f_Z}\right)}{\left(1 + \frac{s}{2 \times \pi \times f_P}\right)}$$

where:

 G_{VD} is the control to output transfer function. $A_{VI} = 20$ A/V. R is the load resistance. f_Z is the zero of G_{VD} . f_P is the domain pole of G_{VD} .

$$f_{Z} = \frac{1}{2 \times \pi \times R_{ESR} \times C_{OUT}}$$

where:

 R_{ESR} is the equivalent series resistance of the output capacitor. C_{OUT} is the output capacitance.

$$f_P = \frac{1}{2 \times \pi \times (R + R_{ESR}) \times C_{OUT}}$$

ADP2389/ADP2390

The ADP2389/ADP2390 use a transconductance amplifier for the error amplifier and to compensate the system. Figure 31 shows the simplified, peak current mode control, small signal circuit.

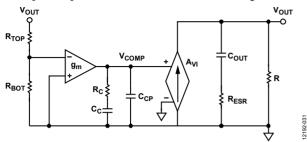


Figure 31. Simplified Peak Current Mode Control, Small Signal Circuit

The compensation components, $R_{\rm C}$ and $C_{\rm C}$, contribute a zero and the optional $C_{\rm CP}$ and $R_{\rm C}$ contribute an optional pole.

The closed-loop transfer equation is as follows:

$$T_{V}(s) = \frac{R_{BOT}}{R_{BOT} + R_{TOP}} \times \frac{-g_{m}}{C_{C} + C_{CP}} \times \frac{1 + R_{C} \times C_{C} \times s}{s \times \left(1 + \frac{R_{C} \times C_{C} \times C_{CP}}{C_{C} + C_{P}} \times s\right)} \times G_{VD}(s)$$

The following design guideline shows how to select the compensation components R_C , C_C , and C_{CP} for ceramic output capacitor applications.

- 1. Determine the cross frequency, $f_{\rm C}.$ Generally, $f_{\rm C}$ is between $f_{sw}/12$ and $f_{sw}/6.$
- 2. Calculate R_C using the following equation:

$$R_{C} = \frac{2 \times \pi \times V_{OUT} \times C_{OUT} \times f_{C}}{0.6 \text{ V} \times g_{m} \times A_{VI}}$$

3. Place the compensation zero at the domain pole, f_{P} and determine C_{C} by

$$C_{C} = \frac{(R + R_{ESR}) \times C_{OUT}}{R_{C}}$$

4. C_{CP} is optional. Use C_{CP} to cancel the zero caused by the ESR of the output capacitor.

$$C_{CP} = \frac{R_{ESR} \times C_{OUT}}{R_C}$$

DESIGN EXAMPLE

This section provides the procedures of selecting the external components based on the example specifications listed in Table 7. The schematic of this design example is shown in Figure 32.

Table 7. Step-Down DC-to-DC Regulator Requirements

| Parameter | Specification |
|-----------------------|-------------------------|
| Input Voltage | 12.0 V ± 10% |
| Output Voltage | 1.2 V |
| Output Current | 12 A |
| Output Voltage Ripple | 12 mV |
| Load Transient | ±5%, 3 A to 9 A, 2 A/μs |
| Switching Frequency | 500 kHz |

OUTPUT VOLTAGE SETTING

Select a 10 k Ω resistor as the top feedback resistor (R_{TOP}) and calculate the bottom feedback resistor (R_{BOT}) using the following equation:

$$R_{BOT} = R_{TOP} \times \left(\frac{0.6}{V_{OUT} - 0.6}\right)$$

To set the output voltage to 1.2 V, the resistors values are $R_{\rm TOP}$ = 10 k Ω and $R_{\rm BOT}$ = 10 k $\Omega.$

FREQUENCY SETTING

Use the following equation to calculate the value of R_T:

$$R_T(k\Omega) = \frac{67,000}{f_{SW}(kHz)} - 12$$

Thus, when $f_{SW} = 500$ kHz, the value of $R_T = 122$ k Ω .

Select the standard resistor value of 121 k Ω for R_{T}

INDUCTOR SELECTION

The peak-to-peak inductor ripple current, ΔI_L , is set to 33% of the maximum output current. Use the following equation to estimate the inductor value:

$$L = \frac{\left(V_{IN} - V_{OUT}\right) \times D}{\Delta I_L \times f_{SW}}$$

where:

 $V_{IN} = 12.0 \text{ V}$ $V_{OUT} = 1.2 \text{ V}$ D = 10% $\Delta I_L = 4 \text{ A}$ $f_{SW} = 500 \text{ kHz}$

This results in L = 0.54 $\mu H.$ Select the standard inductor value of 0.68 $\mu H.$

Calculate the peak-to-peak inductor ripple current using the following equation:

$$\Delta I_{L} = \frac{\left(V_{IN} - V_{OUT}\right) \times D}{L \times f_{SW}}$$

This results in $\Delta I_L = 3.176$ A.

Calculate the peak inductor current with the following equation:

$$I_{PEAK} = I_{OUT} + \frac{\Delta I_L}{2}$$

This results in $I_{PEAK} = 13.588$ A.

Calculate the rms current flowing through the inductor by the following equation:

$$I_{RMS} = \sqrt{I_{OUT}^2 + \frac{\Delta I_L^2}{12}}$$

This results in $I_{RMS} = 12.035$ A.

According to the calculated current value, select an inductor with a minimum rms current rating of 12.035 A and a minimum saturation current rating of 13.588 A.

However, to protect the inductor from reaching its saturation point under a current-limit condition, the inductor must be rated for at least a 20 A saturation current for reliable operation.

Based on these requirements, select a 0.68 μ H inductor, such as the 7443330068 from Würth Elektronik, which has 1.35 m Ω dc resistance (DCR) and a 38 A saturation current.

OUTPUT CAPACITOR SELECTION

The output capacitor must meet both the output voltage ripple requirement and load transient response.

To meet the output voltage ripple requirement, use the following equation to calculate the ESR and capacitance value of the output capacitor:

$$C_{OUT_RIPPLE} = \frac{\Delta I_{L}}{8 \times f_{SW} \times \Delta V_{OUT_RIPPLE}}$$
$$R_{ESR} = \frac{\Delta V_{OUT_RIPPLE}}{\Delta I_{L}}$$

This results in $C_{OUT_RIPPLE} = 66 \ \mu F$ and $R_{ESR} = 3.78 \ m\Omega$.

To meet the $\pm 5\%$ overshoot and undershoot transient requirements, use the following equations to calculate the capacitance:

$$C_{OUT_OV} = \frac{K_{OV} \times \Delta I_{STEP}^{2} \times L}{2 \times (V_{OUT} - \Delta V_{OUT_OV}) - V_{OUT}}$$
$$C_{OUT_UV} = \frac{K_{UV} \times \Delta I_{STEP}^{2} \times L}{2 \times (V_{IN} - V_{OUT}) \times \Delta V_{OUT_UV}}$$

where:

 $K_{OV} = K_{UV} = 2$, and are the coefficients for estimation purpose. $\Delta I_{STEP} = 6$ A, and is the load transient step.

 $\Delta V_{OUT_OV} = 5\% \times V_{OUT}$ and, is the overshoot voltage. $\Delta V_{OUT_UV} = 5\% \times V_{OUT}$, and is the undershoot voltage.

This results in $C_{OUT OV} = 332 \,\mu\text{F}$ and $C_{OUT UV} = 38 \,\mu\text{F}$.

ADP2389/ADP2390

According to the calculations for Cout_RIPPLE, Cout_ov, and $C_{OUT UV}$, the output capacitance must be greater than 332 μ F and the ESR of the output capacitor must be less than 3.78 m Ω . It is recommended that five 100 µF, X5R, 6.3 V ceramic capacitors be used, such as the GRM32ER60J107ME20 from Murata, with an ESR of 2 m Ω .

COMPENSATION COMPONENTS

For better load transient and stability performance, set the cross frequency, f_c , to $f_{SW}/10$. In this case, f_{SW} is running at 500 kHz; therefore, set f_C to 50 kHz.

The 100 µF ceramic output capacitors have a derated value of 62 μF.

$$R_{C} = \frac{2 \times \pi \times 1.2 \text{ V} \times 5 \times 62 \text{ }\mu\text{F} \times 50 \text{ }\text{Hz}}{0.6 \text{ V} \times 500 \text{ }\mu\text{S} \times 20 \text{ }\text{A/V}} = 19.47 \text{ }\text{k}\Omega$$
$$C_{C} = \frac{(0.1 \Omega + 0.002 \Omega) \times 5 \times 62 \mu\text{F}}{19.47 \text{ }\text{k}\Omega} = 1623 \text{ }\text{p}\text{F}$$
$$C_{CP} = \frac{0.002 \Omega \times 5 \times 62 \mu\text{F}}{19.47 \text{ }\text{k}\Omega} = 31.8 \text{ }\text{p}\text{F}$$

Choose the following standard components: $R_c = 20 k\Omega$, $C_c =$ 1500 pF, and $C_{CP} = 33$ pF.

SCHEMATIC FOR DESIGN EXAMPLE

SOFT START TIME PROGRAM

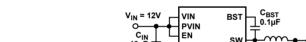
The soft start feature ramps up the output voltage in a controlled manner, eliminating output voltage overshoot during soft start, and limiting the inrush current. Set the soft start time to 4 ms.

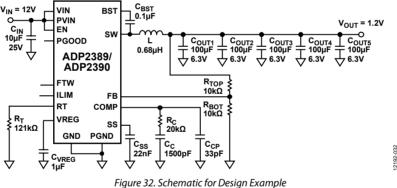
$$C_{ss} = \frac{t_{ss} \times I_{ss}}{0.6 \text{ V}} = \frac{4 \text{ ms} \times 3.4 \,\mu\text{A}}{0.6 \text{ V}} = 22.67 \text{ nF}$$

Choose a standard component value of $C_{SS} = 22 \text{ nF}$.

INPUT CAPACITOR SELECTION

Place a minimum 10 µF ceramic capacitor near the PVIN pin. In this application, one 10 µF, X5R, 25 V ceramic capacitor is recommended.





Rev. 0 | Page 18 of 23

EXTERNAL COMPONENTS RECOMMENDATION

| fsw (kHz) | V _{IN} (V) | V _{OUT} (V) | L (µH) | C _{OUT} (μ F) ¹ | $R_{TOP}(k\Omega)$ | R _{BOT} (kΩ) | Rc (kΩ) | Cc (pF) | С _{СР} (рF) |
|-----------|---------------------|----------------------|--------|--|--------------------|-----------------------|---------|---------|----------------------|
| 300 | 12 | 1 | 0.82 | 680 | 10 | 15 | 21 | 2700 | 330 |
| | 12 | 1.2 | 1 | 470 | 10 | 10 | 18 | 2700 | 270 |
| | 12 | 1.5 | 1 | 5×100 | 15 | 10 | 15 | 2700 | 39 |
| | 12 | 1.8 | 1.2 | 5×100 | 20 | 10 | 18 | 2700 | 33 |
| | 12 | 2.5 | 1.5 | 3×100 | 47.5 | 15 | 15 | 2700 | 22 |
| | 12 | 3.3 | 2.2 | 3×100 | 10 | 2.21 | 20 | 2700 | 18 |
| | 12 | 5 | 2.2 | 100 | 22 | 3 | 10 | 2700 | 10 |
| | 5 | 1 | 0.68 | 470 | 10 | 15 | 15 | 2700 | 330 |
| | 5 | 1.2 | 0.82 | 470 | 10 | 10 | 18 | 2700 | 270 |
| | 5 | 1.5 | 0.82 | 5×100 | 15 | 10 | 12 | 2700 | 39 |
| | 5 | 1.8 | 1 | 4×100 | 20 | 10 | 15 | 2700 | 33 |
| | 5 | 2.5 | 1 | 2×100 | 47.5 | 15 | 10 | 2700 | 22 |
| | 5 | 3.3 | 1 | 2×100 | 10 | 2.21 | 12 | 2700 | 18 |
| 600 | 12 | 1.2 | 0.47 | 4×100 | 10 | 10 | 18 | 1200 | 27 |
| | 12 | 1.5 | 0.47 | 3×100 | 15 | 10 | 18 | 1200 | 22 |
| | 12 | 1.8 | 0.68 | 3×100 | 20 | 10 | 21 | 1200 | 18 |
| | 12 | 2.5 | 0.82 | 2×100 | 47.5 | 15 | 20 | 1200 | 12 |
| | 12 | 3.3 | 1 | 100 | 10 | 2.21 | 12 | 1200 | 10 |
| | 12 | 5 | 1.2 | 100 | 22 | 3 | 20 | 1200 | 6.8 |
| | 5 | 1 | 0.47 | 5×100 | 10 | 15 | 20 | 1200 | 33 |
| | 5 | 1.2 | 0.47 | 4×100 | 10 | 10 | 18 | 1200 | 27 |
| | 5 | 1.5 | 0.47 | 3×100 | 15 | 10 | 18 | 1200 | 22 |
| | 5 | 1.8 | 0.47 | 2×100 | 20 | 10 | 14 | 1200 | 18 |
| | 5 | 2.5 | 0.47 | 100 | 47.5 | 15 | 10 | 1200 | 12 |
| | 5 | 3.3 | 0.47 | 100 | 10 | 2.21 | 12 | 1200 | 10 |
| 1200 | 12 | 2.5 | 0.47 | 100 | 47.5 | 15 | 20 | 680 | 6.8 |
| | 12 | 3.3 | 0.47 | 47 | 10 | 2.21 | 12 | 680 | 4.7 |
| | 12 | 5 | 0.68 | 47 | 22 | 3 | 18 | 680 | 3.3 |
| | 5 | 1 | 0.13 | 2×100 | 10 | 15 | 15 | 680 | 12 |
| | 5 | 1.2 | 0.24 | 2×100 | 10 | 10 | 18 | 680 | 12 |
| | 5 | 1.5 | 0.24 | 2×100 | 15 | 10 | 22.1 | 680 | 10 |
| | 5 | 1.8 | 0.24 | 100 | 20 | 10 | 14 | 680 | 8.2 |
| | 5 | 2.5 | 0.24 | 47 | 47.5 | 15 | 9.1 | 680 | 6.8 |
| | 5 | 3.3 | 0.24 | 47 | 10 | 2.21 | 12 | 680 | 4.7 |

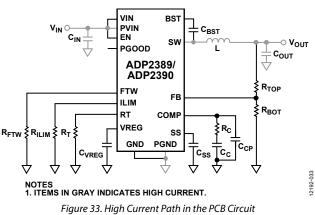
¹ 680 μF: 6.3 V, KEMET T530X687M006ATE010; 470 μF: 6.3 V, KEMET T520X477M006ATE010; 100 μF: 6.3 V, X5R, Murata GRM32ER60J107ME20; 47 μF: 6.3 V, X5R, Murata GRM32ER60J476ME20.

CIRCUIT BOARD LAYOUT RECOMMENDATIONS

Good printed circuit board (PCB) layout is essential for obtaining the best performance from the ADP2389/ADP2390. Poor PCB layout can degrade the output regulation, as well as the EMI and electromagnetic compatibility (EMC) performance. Figure 34 shows an example of a good PCB layout for the ADP2389/ ADP2390. For optimum layout, refer to the following guidelines:

- Use separate analog ground planes and power ground planes. Connect the ground reference of sensitive analog circuitry, such as output voltage divider components, to the analog ground. In addition, connect the ground reference of power components, such as input and output capacitors, to power ground. Connect both ground planes to the exposed GND pad of the ADP2389/ADP2390.
- Place the input capacitor, the inductor, and the output capacitor as close as possible to the IC, and use short traces.
- Ensure that the high current loop traces are as short and as wide as possible. Make the high current path from the input capacitor through the inductor, the output capacitor, and the power ground plane back to the input capacitor as short as possible. To accomplish this, ensure that the input and output capacitors share a common power ground plane. In addition, ensure that the high current path from the power ground plane through the inductor and output capacitor back to the power ground plane is as short as possible by tying the PGND pins of the ADP2389/ADP2390 to the PGND plane as close as possible to the input and output capacitors.

- Connect the exposed GND pad of the ADP2389/ADP2390 to a large, external copper ground plane to maximize its power dissipation capability and minimize junction temperature. In addition, connect the exposed SW pad to the SW pins of the ADP2389/ADP2390, using short, wide traces, or connect the exposed SW pad to a large copper plane of the switching node for high current flow to reduce thermal resistance.
- Place the feedback resistor divider network as close as possible to the FB pin to prevent noise pickup. Minimize the length of the trace that connects the top of the feedback resistor divider to the output while keeping the trace away from the high current traces and the switching node to avoid noise pickup. To reduce noise pickup further, place an analog ground plane on either side of the FB trace and ensure that the trace is as short as possible to reduce the parasitic capacitance pickup.



Data Sheet

ADP2389/ADP2390

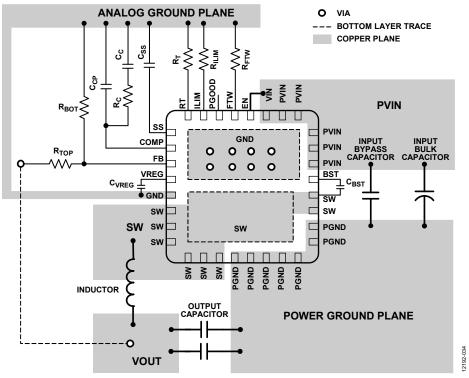


Figure 34. Recommended PCB Layout

TYPICAL APPLICATION CIRCUITS

Figure 35 through Figure 37 show some typical application circuits of the ADP2389/ADP2390 for user information.

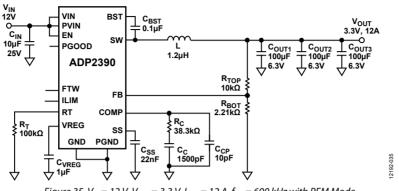


Figure 35. $V_{IN} = 12 V$, $V_{OUT} = 3.3 V$, $I_{OUT} = 12 A$, $f_{SW} = 600 \text{ kHz}$ with PFM Mode

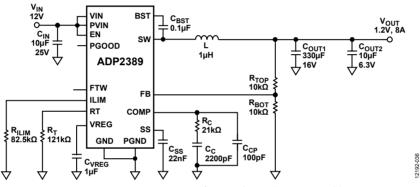
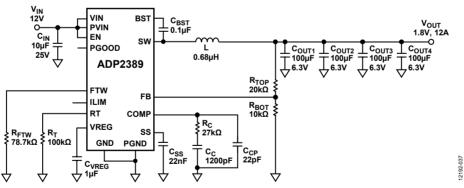
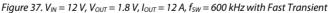
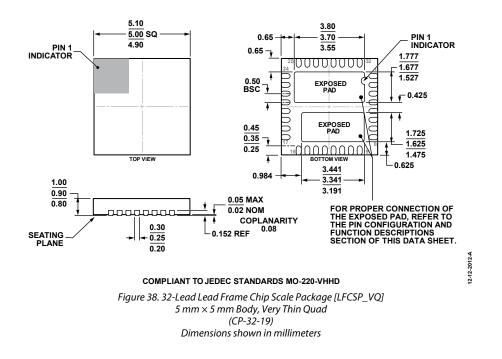


Figure 36. $V_{IN} = 12 V$, $V_{OUT} = 1.2 V$, $I_{OUT} = 8 A$, $f_{SW} = 500 \text{ kHz}$ with Programmable Current Limit





OUTLINE DIMENSIONS



ORDERING GUIDE

| Model ¹ | Temperature Range | Output Voltage | Package Description | Package Option |
|--------------------|-------------------|----------------|--|----------------|
| ADP2389ACPZ-R7 | -40°C to +125°C | Adjustable | 32-Lead Lead Frame Chip Scale Package [LFCSP_VQ] | CP-32-19 |
| ADP2390ACPZ-R7 | -40°C to +125°C | Adjustable | 32-Lead Lead Frame Chip Scale Package [LFCSP_VQ] | CP-32-19 |
| ADP2389-EVALZ | | | Evaluation Board | |
| ADP2390-EVALZ | | | Evaluation Board | |

¹ Z = RoHS Compliant Part.

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Rev. 0 | Page 23 of 23

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